

ack surface

HiPerDynFRED[™] with soft recovery (Electrically Isolated Back Surface)

V _{RSM} V	V _{RRM} V	Туре
1200	1200	DSEP 30-12CR

A	
0-	U



= 20 ns

= 30 A

 $V_{\rm RRM} = 1200 \, \rm V$

A = Anode, C = Cathode

* Patent pending

Symbol	Conditions	Maximum	Maximum Ratings	
IFRMS		70		
FAVM	$T_c = 85^{\circ}C$; rectangular, d = 0.5	30	А	
I _{FRM}	t_P < 10 µs; rep. rating, pulse width limited	by T _{VJM} tbd	А	
I _{FSM}	$T_{vJ} = 45^{\circ}C; t_p = 10 \text{ ms} (50 \text{ Hz}), \text{ sine}$	250	A	
E _{AS}	$T_{VJ} = 25^{\circ}C$; non-repetitive $I_{AS} = 1.3 A$; L = 180 µH	0.2	mJ	
I _{AR}	$V_A = 1.25 \cdot V_R$ typ.; f = 10 kHz; repetitive	0.1	A	
T _{VJ}		-55+175	°C	
T _{VJM}		175	°C	
T _{stg}		-55+150	°C	
P _{tot}	$T_c = 25^{\circ}C$	165	W	
VISOL	50/60 Hz RMS; $I_{ISOL} \le 1 \text{ mA}$	2.5	kV	
Mounting for	orce with clip	1050/210	N/lb.	
Weight	typical	6	g	

Symbol	Conditions	Characteristic Values typ. max.		
I _R ①	$\begin{array}{l} T_{VJ}=25^{\circ}C V_{R}=V_{RRM} \\ T_{VJ}=150^{\circ}C \ V_{R}=V_{RRM} \end{array}$		250 2	μA mA
V _F ②	$I_F = 30 \text{ A};$ $T_{VJ} = 150^{\circ}\text{C}$ $T_{VJ} = 25^{\circ}\text{C}$		3.1 5.0	V V
R _{thJC} R _{thCH}	with heatsink compound	0.25	0.9	K/W K/W
t _{rr}	$I_F = 1 \text{ A}; -di/dt = 200 \text{ A}/\mu\text{s};$ $V_R = 30 \text{ V}; \text{ T}_{VJ} = 25^{\circ}\text{C}$	20		ns
I _{RM}	$V_{R} = 100 \text{ V}; \ I_{F} = 50 \text{ A}; -di_{F}/dt = 100 \text{ A}/\mu\text{s}$ $T_{VJ} = 100^{\circ}\text{C}$	4.0		A

Pulse test: ① Pulse Width = 5 ms, Duty Cycle < 2.0 %② Pulse Width = 300μ s, Duty Cycle < 2.0 %

Data according to IEC 60747 and per diode unless otherwise specified

IXYS reserves the right to change limits, test conditions and dimensions.

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Features

t_{rr}

с 0

- Silicon chip on Direct-Copper-Bond substrate
- High power dissipation
- Isolated mounting surface
- 2500V electrical isolation
- Low cathode to tab capacitance (<25pF)
- International standard package
- Planar passivated chips
- Very short recovery time
- Extremely low switching losses
- \bullet Low $I_{\mbox{\tiny RM}}\mbox{-}values$
- Soft recovery behaviour
- Epoxy meets UL 94V-0
- Isolated and UL registered E153432

Applications

- Antiparallel diode for high frequency switching devices
- Antisaturation diode
- Snubber diode
- Free wheeling diode in converters and motor control circuits
- Rectifiers in switch mode power supplies (SMPS)
- Inductive heating
- Uninterruptible power supplies (UPS)
- Ultrasonic cleaners and welders

Advantages

- Avalanche voltage rated for reliable operation
- Soft reverse recovery for low EMI/RFI
- Low I_{RM} reduces:
- Power dissipation within the diodeTurn-on loss in the commutating
- switch • ISOPLUS 247[™] package for clip or
- spring mounting

Dimensions see IXYS CD 2000